

# Harvatek Surface Mount CHIP LED Data Sheet B3233GBR-20C0002Q3U1930

Official Product	Product HT Part No. B3233GBR-20C0002Q3U1930						
Tentative Product	*******						
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DISCLAIMER	3
PRODUCT SPECIFICATIONS	4
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION	4
LABEL SPECIFICATIONS	5
PRODUCT FEATURES	7
ELECTRO-OPTICAL CHARACTERISTICS	7
ABSOLUTE MAXIMUM RATINGS	
Precaution for Use	
CHARACTERISTICS OF B3233GBR	9
PACKAGING	10
TAPE DIMENSION	10
REEL DIMENSION	11
Packing	11
DRY PACK	12
Baking	12
Precautions	12
REFLOW SOLDERING	13
Reworking	13
CLEANING	13
REVISE HISTORY	14

Official Product	HT Part No. B3233GBR-20C0002Q3U1930					
Tentative Product	********					
	ct to changes for improvement without advance drawings, company confidential all rights reserved.	03/17/2021	Version 1.0	Page 2/14		



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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	HT Part No. B3233GBR-20C0002Q3U1930					
Tentative Product	********					
	ct to changes for improvement without advance drawings, company confidential all rights reserved.	03/17/2021	Version 1.0	Page 3/14		



## **Product Specifications**

	Specification	Material	Quantity
Luminous	R :71.5-285.0 mcd		
Intensity(Iv)	G :180.0-450.0 mcd		
	B: 45.0-180.0 mcd		
	R/G/B@20mA/ Ts= $25^{\circ}$ C;Tolerance $\pm 10\%$		
Wavelength	R : 615-630 nm		
	G : 515-530 nm		
	B : 460-475 nm		
	R/G/B@20mA/ Ts= $25^{\circ}$ C;Tolerance $\pm$ 0.5nm		
Vf	R : 1.6-2.4 V		
	G : 2.7-3.9 V		
	B : 2.7-3.9 V		
	R/G/B@20mA/ Ts= $25^{\circ}$ C;Tolerance $\pm 0.05$ V		
Ir	< 10 μA @ V <sub>R</sub> = 5 V		
Resin	Water clear	Ероху	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

## ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be

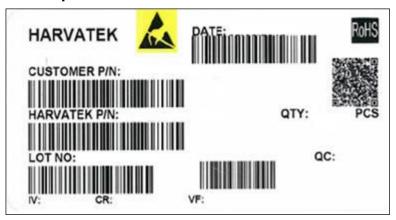
taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Official Product	HT Part No. B3233GBR-20C0002Q3U1930					
Tentative Product	*******					
	ct to changes for improvement without advance drawings, company confidential all rights reserved.	03/17/2021	Version 1.0	Page 4/14		



## **Label Specifications**



#### Harvatek P/N:

B 323 3 GBR- 20C- 0002 Q3

Product	Package	Dice Qty	Color	Current	Series Number	Taping
B:PCB	2.7(L)x1.35(W)x0.8(H)mm	3:Single	G : Green	20mA	X001~XZZZ	1.Taping style
			B : Blue			2. Qty
			R : Red			

## Lot No.

1 2	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutiv	ve number		Special code	2
Internal Tracing (	nternal Tracing Code		1:Jan. 2:Feb.  A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C  26:Z 27:7 28:8 29:9 30:3 31:4	01~	-zz		000-ZZZ	

Official Product	HT Part No. B3233GBR-20C0002Q3U1930					
Tentative Product	*******					
	ct to changes for improvement without advance drawings, company confidential all rights reserved.	03/17/2021	Version 1.0	Page 5/14		



## Bin code

## **■** Luminous Intensity (Iv)

B3233GBR@20mA bin code								
IV(mcd)								
	R		G			В		
Q	71.5	112.5	S	180.0	285.0	Р	45.0	71.5
R	112.5	180.0	Т	285.0	360.0	Q	71.5	112.5
S	180.0	285.0	U	360.0	450.0	R	112.5	180.0

Note: It maintains a tolerance of ±10% on Luminous Intensity

## **■** Dominant Wavelength (λ<sub>D</sub>)

B3233GBR @20mA bin code							
WD(nm)							
	R	G		В			
AC	615~630	А	515~520	AA	460~465		
		В	520~525	AB	465~470		
		С	525~530	AC	470~475		

Note: It maintains a tolerance of ±0.5nm on Wavelength Bin

# **■** Forward Voltage (Vf)

B3233GBR @20mA bin code						
Vf(V)						
	R		G		В	
E18	1.6~2.4	G4C	2.7~3.9	G4C	2.7-3.9	

Note: It maintains a tolerance of ±0.05V on forward voltage measurements

Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	*******			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 6/14	



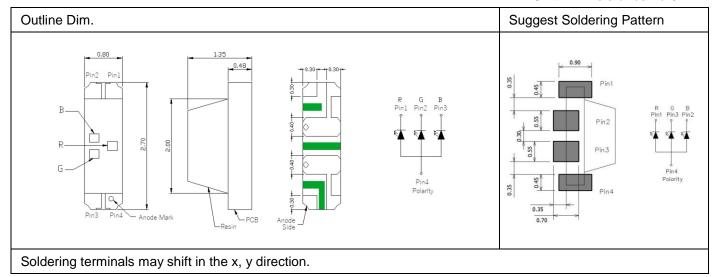
## **Product Features**

## **Electro-Optical Characteristics**

(IF Red & Green &Blue@20mA, Ta 25 °C)

Part number	Emitting Forward Wavelength rt number Color Voltage(VF) (nm) typ.			I <sup>*</sup> <sub>V</sub> (mcd)		IF(mA)	Viewing Angle 2 <del>0</del> 1/2			
		typ.	max.	λD	λр	Δλ	min.	typ.		Angle 201/2
	Ultra Bright Red	2.0	2.4	624	632	20	71.5	112.5		
B3233GBR-20	Green	3.3	3.9	525	520	30	180	360	20	130
	Blue	3.3	3.9	470	468	40	45	71.5		

Unit: mm Tolerance: +/-0.1



## **Absolute Maximum Ratings**

(T<sub>a</sub> 25 °C)

Series	P <sub>D</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)*	T <sub>OP</sub> (°C)	T <sub>ST</sub> (℃)
Color	Power	Forward	Forward Pulse Forward Operating		Storage
Coloi	Dissipation	Current	Current	Temperature	Temperature
R	48	20	100	-40~+85	-40~+100
G	78	20	80	-40~+85	-40~+100
В	78	20	80	-40~+85	-40~+100

<sup>\*</sup>Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1msec width

Official Product	HT Part No. B3233GBR-20C0002Q3U1930			
Tentative Product	********	*******		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 7/14



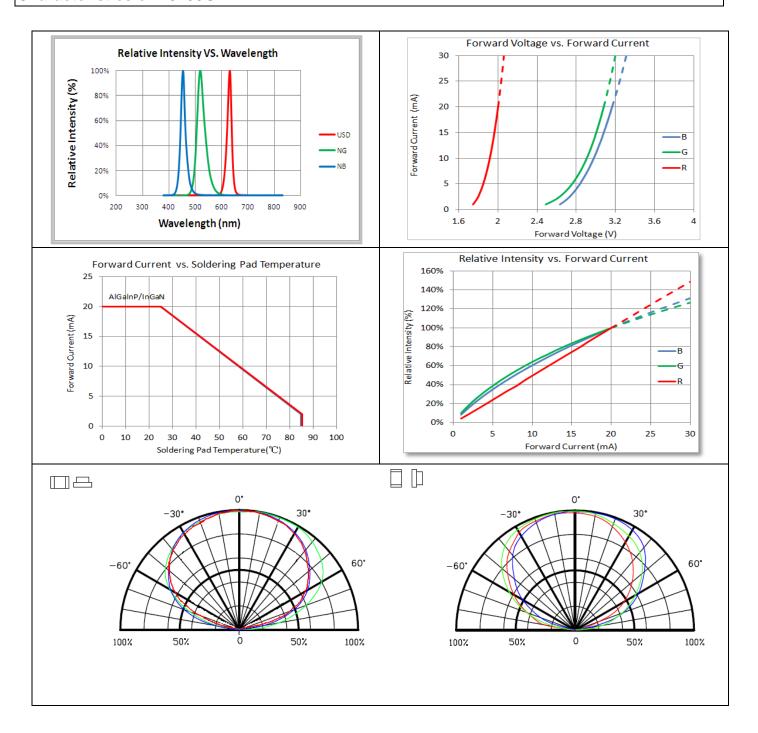
#### **Precaution for Use**

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	********			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 8/14	



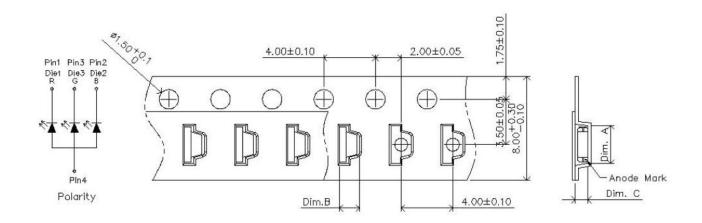
#### Characteristics of B3233GBR



Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	******	**		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 9/14	

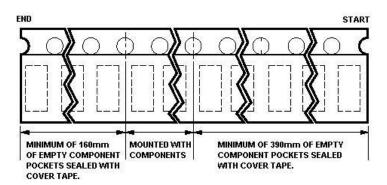


# Packaging Tape Dimension



Dim. A	Dim. B	Dim. K0	Qty/Reel
2.9±0.10	1.55±0.10	1.00±0.10	3K

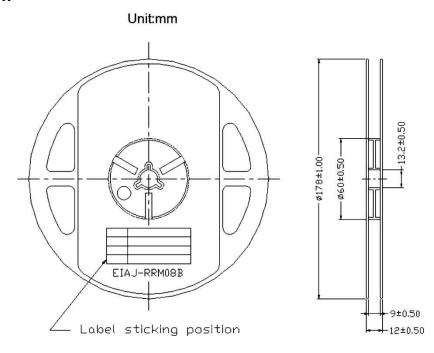
Unit: mm



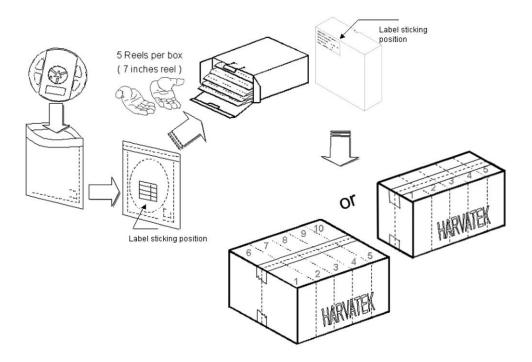
Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	*******			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 10/14	



## **Reel Dimension**



## **Packing**



5 or 10 boxes per carton is available depending on shipment quantity.

Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	*******			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 11/14	

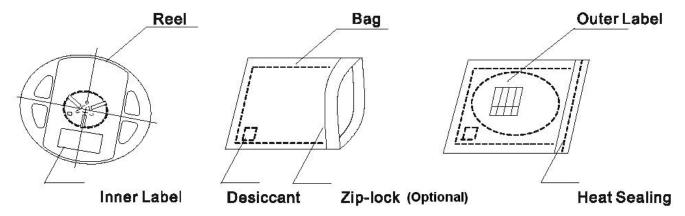


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



## **Baking**

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1.  $60\pm3$ °C×(12~24hrs)and<5%RH, taped reel type.
- 2.  $100\pm3$ °C×(45min~1hr), bulk type.
- 3. 130±3°C×(15min~30min), bulk type.

#### **Precautions**

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	******	**		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 12/14	

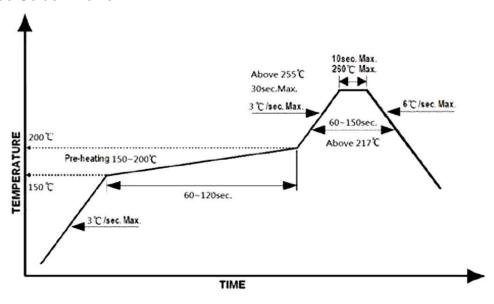


## **Reflow Soldering**

Recommend soldering paste specifications:

- Operating temp.: Above 217°C ,60~150 sec
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



### Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min</li>
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter</li>
- Curing: 100°C max, <3min</li>

Official Product	HT Part No. B3233GBR-20C0002Q3U1930				
Tentative Product	********	*******			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 13/14	



## **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

## **Revise History**

Rev.	Descriptions	Date	Page
1.0		03/17/2021	-

Official Product	HT Part No. B3233GBR-20C0002Q3U1930			
Tentative Product	********	********		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		03/17/2021	Version 1.0	Page 14/14